

# PRODUCT/PROCESS CHANGE NOTIFICATION

PCN APM-PWR/07/2316 Notification Date 02/13/2007

Second source for M174 package R.F.

PWR - PWR BIP/ IGBT/ RF

#### **Table 1. Change Identification**

Product Identification (Product Family/Commercial Product)	see attached file				
Type of change	Package assembly location change				
Reason for change	to assure a second source				
Description of the change	The new package is identical to the current one, both from mechanical and electrical point of view, except for the flange finishing which is Nickel for the current version and Gold for the new version. A second source supplier will allow an improvement of service to our customers, by reducing the standard lead time related to the involved devices.				
Product Line(s) and/or Part Number(s)	See attached				
Description of the Qualification Plan	See attached				
Change Product Identification	Flange with different color (sse attached file)				
Manufacturing Location(s)					

#### **Table 2. Change Implementation Schedule**

Forecasted implementation date for change	15-May-2007
Forecasted availabillity date of samples for customer	06-Feb-2007
Forecasted date for <b>STMicroelectronics</b> change Qualification Plan results availability	06-Feb-2007
Estimated date of changed product first shipment	31-May-2007

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Customer Part numbers list	
Qualification Plan results	

Customer Acknowledgement of Receipt	PCN APM-PWR/07/2316
Please sign and return to STMicroelectronics Sales Office	Notification Date 02/13/2007
□ Qualification Plan Denied	Name:
□ Qualification Plan Approved	Title:
	Company:
□ Change Denied	Date:
□ Change Approved	Signature:
Remark	
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#### **DOCUMENT APPROVAL**

Name	Function		
Juhel, Serge	Division Marketing Manager		
Vitanza, Aldo	Division Product Manager		
Spampinato, Sergio Tommas	Division Q.A. Manager		

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#### MPA (Micro, Power, Analog) Group Voltage Regulator, Interface, Advanced logic & Power RF Quality & Reliability

Rel 6337-274W06

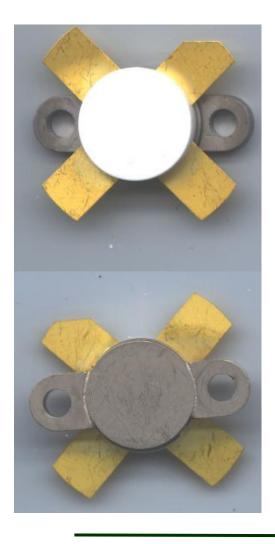
#### Reliability Evaluation On

## Line: 1411 BIPOLAR RF Power TECHNOLOGY

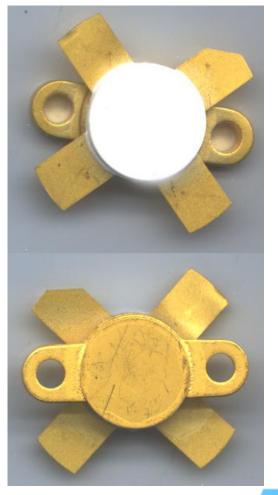
Package: M174 (Epoxy Sealed) - Zentrix RFI136

Test	Conditions	S.S.	Requirement	RESULTS		Generic data	
							End of step
		22.1	Parameter deviation	168h	500h	1Kh	
H.T.S.	TA=200°C	77x1 Lot	within spec. limits at 1000h	0/77	0/77	0/77	0/154
H.T.R.B.	TA=175°C	22.1	Parameter deviation	168h	500h	1Kh	
11.1.K.D.	Vcc= 80V	Lot	77x1 Lot within spec. limits at 1000h	0/77	0/77	0/77	0/154
THERMAL	TA=-65°C TO 150°C	22.1	Parameter deviation	100cy	500cy		
CYCLES AIR TO AIR	1 HOUR/CYCLE	77x1 Lot	within spec. limits at 500cycles	0/77	0/77		0/154
MECHANICAL SEQUENCE	-Mechanical Shock: a= 1500 g; t=.5msec 5 shocks x 6 orientations -Vibration: a= 20g; f= 100/2000Hz 4' x 3 orient. X 4 cycles = 48' -Constant acceleration: a= 2000/3000g for 1' -Fine leak test	32x1 Lot	Parameter deviation within spec. limits at end of test	0/32			0/64

## **CURRENT**



## **SECOND SOURCE**



6-Feb-07

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